POLYLACTIC ACID RESIN COMPOSITION

Publication number: JP11116788

Publication date: 1999-04-27

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Classification:

- international: C08J3/18; B29C55/28; C08G63/06; C08J5/00; C08J5/18; C08L67/04; C08L101/16; B29K67/00; B29L7/00; C08J3/18; B29C55/28; C08G63/00;

C08J5/00; C08J5/18; C08L67/00; C08L101/00; C08J5/00; (IPC1-7): C08J5/00; C08L67/04; B29C55/28; C08G63/06; C08J3/18; C08J5/18; B29K67/00; B29L7/00

- European: Application number: JP19970277644 19971009

Application number: JP19970277644 19971009 Priority number(s): JP19970277644 19971009

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Abstract of JP11116788

PROBLEM TO BE SOLVED. To obtain a resin compan, which has both softness and heat resistance by compounding a high-molecular component comprising polyladic sold and a biolograpidable aligh, polyster in a specified ratio with a specified ant. Or a biologradable plasticizer. SOLUTION: This compan. contains 100 pt.swt. polymer component comprising 90-50 wth. Solvaticize and and 10-50 wth. Solvaticize and solvation solvation and in recessary an integrit filter of section solvation. And if necessary an integrit filter of section solvation is solved to section solvation. And in recessary an integrit filter of section solvation solvation solvation. And in section solvation of 2,000-10,000 (grown-2) and a heat stabilizer, an ultravolvation solvation solvation solvation solvation solvation solvation. And the solvation solvation. And the solvation solv

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